

GaAs INTEGRATED CIRCUIT $\mu PG2158T5K$

L, S-BAND SPDT SWITCH

DESCRIPTION

The μ PG2158T5K is a GaAs MMIC for L, S-band SPDT (Single Pole Double Throw) switch which was developed for mobile phone and another L, S-band application.

This device can operate 2 control switching by control voltage 1.8 to 5.3 V. This device can operate frequency from 0.05 to 3.0 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSSON (<u>Thin Shrink Small Out-line Non-leaded</u>) package. And this package is able to high-density surface mounting.

FEATURES

•	Switch control voltage	: V _{cont} (H) = 1.8 to 5.3 V (2.7 V TYP.)
		: V_{cont} (L) = -0.2 to +0.2 V (0 V TYP.)
٠	Low insertion loss	: LINS1 = 0.40 dB TYP. @ f = 0.05 to 1.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: LINS2 = 0.45 dB TYP. @ f = 1.0 to 2.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: LINS3 = 0.47 dB TYP. @ f = 2.0 to 2.5 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: LINS4 = 0.53 dB TYP. @ f = 2.5 to 3.0 GHz, V cont (H) = 2.7 V, V cont (L) = 0 V
٠	High isolation	: ISL1 = 27 dB TYP. @ f = 0.05 to 1.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: ISL2 = 19 dB TYP. @ f = 1.0 to 2.0 GHz, $V_{cont (H)} = 2.7 V$, $V_{cont (L)} = 0 V$
		: ISL3 = 17 dB TYP. @ f = 2.0 to 2.5 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: ISL4 = 17 dB TYP. @ f = 2.5 to 3.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
٠	Handling power	: Pin (0.1 dB) = +29.0 dBm TYP. @ f = 2.0/2.5 GHz, V cont (H) = 2.7 V, V cont (L) = 0 V
		: Pin (1 dB) = +30.5 dBm TYP. @ f = 2.0/2.5 GHz, V cont (H) = 2.7 V, V cont (L) = 0 V
•	High-density surface mounting	: 6-pin plastic TSSON package ($1.0 \times 1.0 \times 0.37$ mm)

APPLICATIONS

- L, S-band digital cellular or cordless telephone
- W-LAN, WLL and Bluetooth[™] etc.

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
<i>µ</i> PG2158T5K-E2	μPG2158T5K-E2-A	6-pin plastic TSSON (Pb-Free) ^{Note}	G2	 Embossed tape 8 mm wide Pin 1, 6 face the perforation side of the tape Qty 5 kpcs/reel

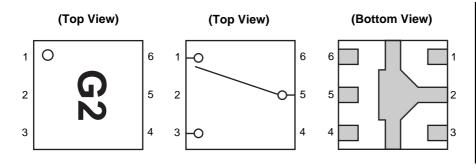
Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

Remark To order evaluation samples, contact your nearby sales office. Part number for sample order: μ PG2158T5K-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	OUTPUT1
2	GND
3	OUTPUT2
4	V _{cont} 2
5	INPUT
6	V _{cont} 1

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TRUTH TABLE

V _{cont} 1	/cont1 Vcont2 INPUT-OUTPUT1		INPUT-OUTPUT2	
Low	High	OFF	ON	
High	Low	ON	OFF	

ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	Vcont	+6.0 ^{Note}	v
Input Power	Pin	+31	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	Tstg	-55 to +150	°C

Note $|V_{cont}1 - V_{cont}2| \le 6.0 \text{ V}$

RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	Vcont (H)	1.8	2.7	5.3	V
Switch Control Voltage (L)	Vcont (L)	-0.2	0	+0.2	V

ELECTRICAL CHARACTERISTICS 1

(TA = +25°C, V_{cont} (H) = 2.7 V, V_{cont} (L) = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 0.05 to 1.0 GHz ^{Note 1}	-	0.40	0.45	dB
Insertion Loss 2	Lins2	f = 1.0 to 2.0 GHz	-	0.45	0.50	
Insertion Loss 3	Lins3	f = 2.0 to 2.5 GHz	-	0.47	0.55	
Insertion Loss 4	Lins4	f = 2.5 to 3.0 GHz	-	0.53	0.60	
Isolation 1	ISL1	f = 0.05 to 1.0 GHz ^{Note 1}	23	27	-	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz	16	19	-	
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	14	17	-	
Isolation 4	ISL4	f = 2.5 to 3.0 GHz	14	17	-	
Input Return Loss	RLin	f = 0.05 to 3.0 GHz ^{Note 1}	15	20	-	dB
Output Return Loss	RLout	f = 0.05 to 3.0 GHz ^{Note 1}	15	20	-	dB
0.1 dB Loss Compression	Pin (0.1 dB)	f = 2.0/2.5 GHz	+26.0	+29.0		dBm
Input Power Note 2		f = 0.5 to 3.0 GHz	-	+29.0		
1 dB Loss Compression Input Power ^{Note 3}	Pin (1 dB)	f = 0.5 to 3.0 GHz	2	+30.5		dBm
2nd Harmonics	2fo	f = 2.0/2.5 GHz, Pin = +20 dBm	65	75	-	dBc
3rd Harmonics	3f o	f = 2.0/2.5 GHz, Pin = +20 dBm	65	75		dBc
Input 3rd Order Distortion Intercept Point	IIP3	f = 0.5 to 3.0 GHz 2 tone 5 MHz spacing		+60	9	dBm
Switch Control Current	Icont	No signal		0.2	20	μA
Switch Control Speed	tsw	50% CTL to 90/10% RF	/-	50	500	ns

Notes 1. DC cut capacitors = 1 000 pF at f = 0.05 to 0.5 GHz

2. Pin (0.1 dB) is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

3. Pin (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system. The range of recommended DC cut capacitor value is less than 100 pF.

ELECTRICAL CHARACTERISTICS 2

(TA = +25°C, V_{cont} (H) = 1.8 V, V_{cont} (L) = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 0.05 to 1.0 GHz Note 1	-	0.40	0.47	dB
Insertion Loss 2	Lins2	f = 1.0 to 2.0 GHz	-	0.46	0.52	
Insertion Loss 3	Lins3	f = 2.0 to 2.5 GHz	-	0.48	0.57	
Insertion Loss 4	Lins4	f = 2.5 to 3.0 GHz	-	0.54	0.62	
Isolation 1	ISL1	f = 0.05 to 1.0 GHz ^{Note 1}	23	27	-	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz	16	19	-	
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	14	17	-	
Isolation 4	ISL4	f = 2.5 to 3.0 GHz	14	17	-	
Input Return Loss	RLin	f = 0.05 to 3.0 GHz ^{Note 1}	15	20	-	dB
Output Return Loss	RLout	f = 0.05 to 3.0 GHz ^{Note 1}	15	20	-	dB
0.1 dB Loss Compression	P in (0.1 dB)	f = 2.0/2.5 GHz	+19.0	+22.0		dBm
Input Power ^{Note 2}		f = 0.5 to 3.0 GHz	-	+22.0		
1 dB Loss Compression Input Power ^{Note 3}	Pin (1 dB)	f = 0.5 to 3.0 GHz	2	+25.0		dBm
Switch Control Current	Icont	No signal		0.2	20	μA
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	50	500	ns

Notes 1. DC cut capacitors = 1 000 pF at f = 0.05 to 0.5 GHz

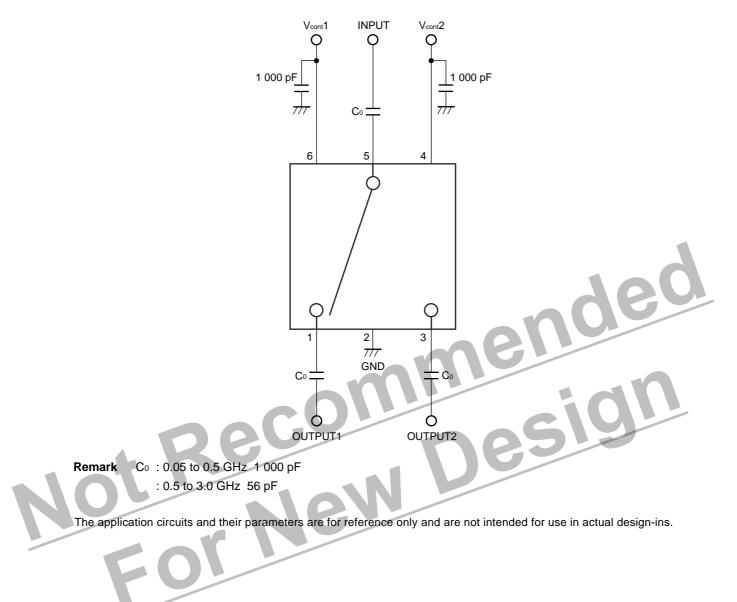
2. Pin (0.1 dB) is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

3. Pin (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system. The range of recommended DC cut capacitor value is less than 100 pF.

EVALUATION CIRCUIT



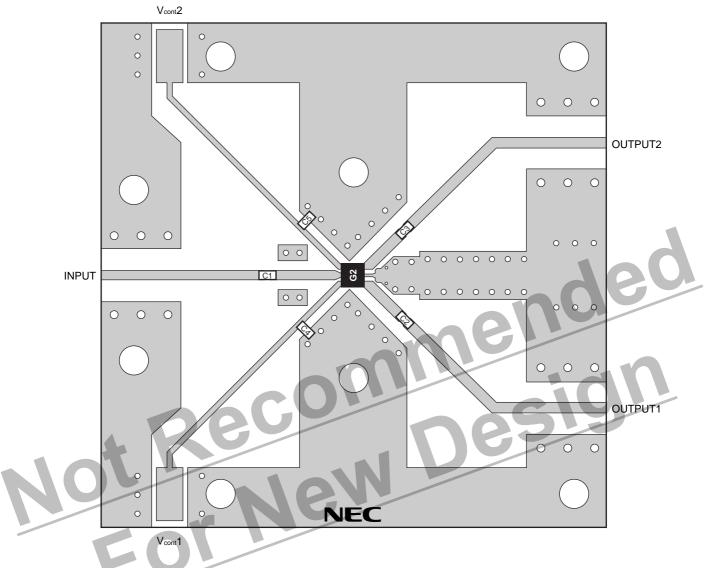
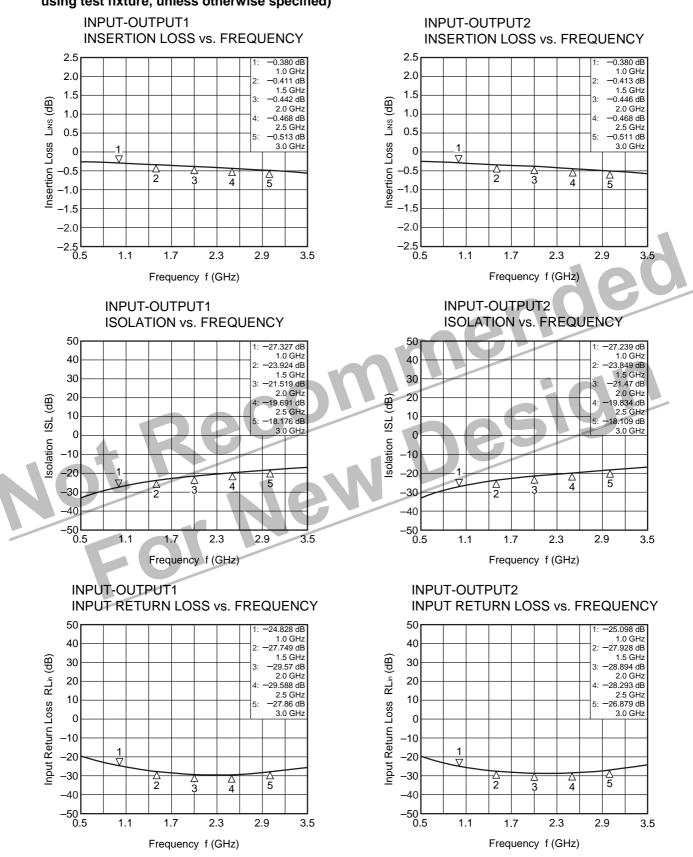


ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

USING THE NEC EVALUATION BOARD

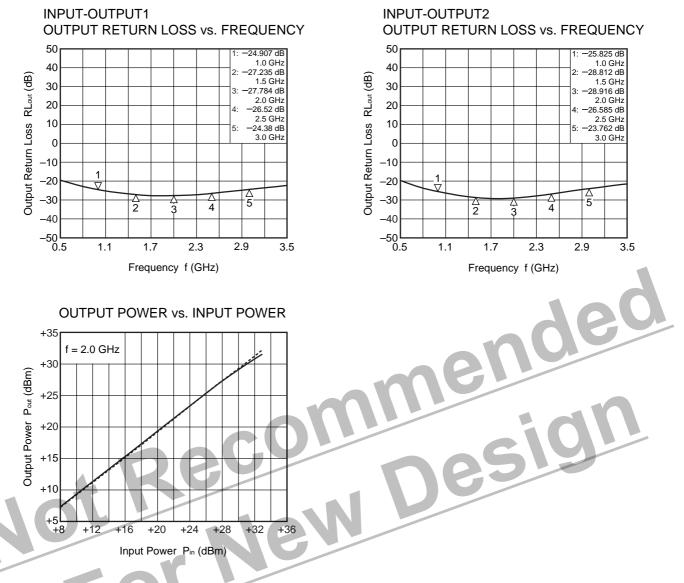
Symbol	Values
C1, C2, C3	56 pF
C4, C5	1 000 pF

TYPICAL CHARACTERISTICS ($T_A = +25^{\circ}C$, V_{cont} (H) = 2.7 V, V_{cont} (L) = 0 V, DC cut capacitors = 56 pF, using test fixture, unless otherwise specified)



Remark The graphs indicate nominal characteristics.

Data Sheet PG10578EJ02V0DS

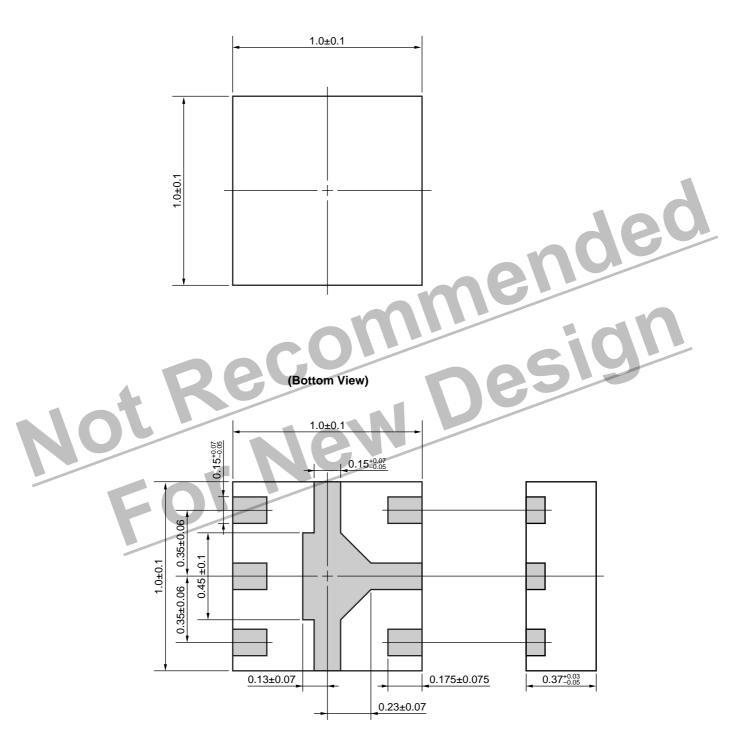




★ PACKAGE DIMENSIONS

6-PIN PLASTIC TSSON (UNIT: mm)

(Top View)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher	: 260°C or below : 10 seconds or less : 60 seconds or less	IR260
	Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 120±30 seconds : 3 times : 0.2%(Wt.) or below	
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

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This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices
Lead (Pb)	< 1000 PPM	-A -AZ Not Detected (*)
Mercury	< 1000 PPM	Not Detected
Cadmium	< 100 PPM	Not Detected
Hexavalent Chromium	< 1000 PPM	Not Detected
РВВ	< 1000 PPM	Not Detected
PBDE	< 1000 PPM	Not Detected

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